## NUC2401 MN

## Integrated Common Mode Choke with Integrated ESD Protection

## Description

The NUC2401MN is an Integrated Common Mode Filter for the elimination of common mode noise in high speed data line applications such as IEEE1394, USB2.0 and other LVDS type applications. ESD protection is integrated into the Common mode filter for superior protection and significant part count reduction.

## Features

- Common mode EMI Filtering and ESD Protection
- Integration of 5 Discrete components
- $\pm 12 \mathrm{kV}$ ESD Protection per IEC61000-4-2 (Contact Discharge)
- DFN: $2.0 \times 2.2 \mathrm{~mm}$ Package
- Moisture Sensitivity Level 1
- ESD Rating: Machine Model (MM) = 1.6 kV ; Human Body Model $(\mathrm{HBM})=16 \mathrm{kV}$
- This is a $\mathrm{Pb}-$ Free Device


## Benefits

- Reduces EMI/RFI Emissions on a Data Line
- Integrated Solution offers Cost and Space Savings
- Reduces Parasitic Inductances Which Offer a More "Ideal" Common Mode Filtering
- Integrated Solution Improves System Reliability


## Applications

- High Speed Differential Data Lines
- USB2.0
- IEEE1394
- LVDS
- MIPI
- MDDI

*NOTE: Pins 1 and 9, Pins 2 and 10, Pins 7 and 11, Pins 8 and 12 are internally connected in pairs. It is recommended not to solder to Pins 9, 10, 11, 12.


## ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| NUC2401MNTAG | DFN8 <br> (Pb-Free) | 3000/Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## NUC2401MN

MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise stated)

| Parameter | Symbol | Value | Units |
| :--- | :---: | :---: | :---: |
| ESD Discharge IEC61000-4-2 Contact Discharge | $\mathrm{V}_{\mathrm{PP}}$ | $\pm 12$ | $\mathrm{kV}^{\prime}$ |
| Operating Temperature Range | $\mathrm{T}_{\mathrm{OP}}$ | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {STG }}$ | -55 to 125 | ${ }^{\circ} \mathrm{C}$ |
| Maximum Lead Temperature for Soldering Purposes (1/8" from Case for 10 Seconds) | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C}$ |
| DC Current per Line | $\mathrm{I}_{\mathrm{LINE}}$ | 100 | mA |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS $\left(T_{A}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Reverse Working Voltage | $\mathrm{V}_{\mathrm{RWM}}$ |  |  |  | 5.0 | V |
| Breakdown Voltage | $\mathrm{V}_{\mathrm{BR}}$ | $\mathrm{I}_{\mathrm{R}}=1 \mathrm{~mA}$ | 6.0 | 7.6 | 8.6 | V |
| Leakage Current | $\mathrm{I}_{\mathrm{R}}$ | $\mathrm{V}_{\mathrm{RWM}}=5.5 \mathrm{~V}$ |  |  | 2.0 | $\mu \mathrm{~A}$ |
| Maximum Peak Pulse Current | $\mathrm{I}_{\mathrm{PP}}$ | $8 \times 20$ us Waveform |  | 10 | 19 | A |
| Clamping Voltage | $\mathrm{V}_{\mathrm{C}}$ | $\mathrm{I}_{\mathrm{PP}}=5 \mathrm{~A}$ |  |  | 10 | V |
| Resistance Pin 1 to Pin 8 | $\mathrm{R}_{\mathrm{A}}$ |  |  | 2.2 | 5.0 | $\Omega$ |
| Resistance Pin 2 to Pin 7 | $\mathrm{R}_{\mathrm{B}}$ |  |  | 2.2 | 5.0 | $\Omega$ |
| Capacitance (Note 1) | $\mathrm{C}_{\mathrm{LINE}} 1$ |  | 0.8 | 1.0 | pF |  |
| Capacitance (Note 2) | $\mathrm{C}_{\mathrm{LINE}} 2$ |  | 0.8 | 1.0 | pF |  |
| Common Mode Cut-Off Frequency (Note 3) | $\mathrm{f}_{3 \mathrm{~dB}}$ | (Above this Frequency, Appreciable <br> Common Mode Attenuation Occurs) |  | 40 |  | MHz |
| Common Mode Impedance | @ 100 MHz |  | 90 |  | $\Omega$ |  |

1. Measured at $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{R}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$, Pins 1 or 4 to GND .
2. Measured at $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{R}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$, Pins 8 or 5 to GND.
3. $50 \Omega$ source and $50 \Omega$ load termination.


Figure 1. Impedance Characteristics vs. Frequency


Figure 2. Insertion Loss Characteristics vs. Frequency

## NUC2401MN



Figure 3. Normal (Differential) Mode Test Configuration


Figure 4. Application Circuit

## PACKAGE DIMENSIONS

## DFN8, 2.2x2, 0.5P

 CASE 506BL-01ISSUE O


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. EXPOSED ENDS OF THE TERMINALS ARE ELECTRICALLY ACTIVE.

|  | MILLIMETERS |  |
| :---: | :---: | :---: |
| DIM | MIN | MAX |
| A | 0.85 | 0.95 |
| A1 | 0.00 | 0.05 |
| A3 | 0.20 | REF |
| b | 0.15 | 0.25 |
| D | 2.20 |  |
| D2 | 0.34 | 0.54 |
| E | 2.00 |  |
| E2 | 0.60 | 0.80 |
| e | 0.50 | 0.80 |
| K | 0.20 | --- |
| L | 0.30 | 0.50 |
| L1 | --- | 0.15 |



SOLDERING FOOTPRINT*


DIMENSIONS: MILLIMETERS
*For additional information on our Pb -Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.


#### Abstract

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